

CMOS LDO Regulator Series for Portable Equipments

Versatile Package FULL CMOS LDO Regulator



BUxxTD3WG series

General Description

BUxxTD3WG series is high-performance FULL CMOS regulator with 200-mA output, which is mounted on versatile package SSOP5 (2.9 mm \times 2.8 mm \times 1.25 mm). It has excellent noise characteristics and load responsiveness characteristics despite its low circuit current consumption of $35\mu A.$ It is most appropriate for various applications such as power supplies for logic IC, RF, and camera modules.ROHM's.

Features

- High accuracy detection
- low current consumption
- Compatible with small ceramic capacitor(Cin=Co=0.47uF)
- With built-in output discharge circuit
- High ripple rejection
- ON/OFF control of output voltage
- With built-in over current protection circuit and thermal shutdown circuit
- Package SSOP5 is similar to SOT-23-5 (JEDEC)
- Low dropout voltage

Key Specifications

■ Output voltage: 1.0V to 3.4V
 ■ Accuracy output voltage: ±1.0% (±25mV)
 ■ Low current consumption: 35µA
 ■ Operating temperature range: -40°C to +85°C

Applications

Battery-powered portable equipment, etc.

Package

SSOP5: 2.90mm x 2.80mm x 1.25mm



● Typical Application Circuit

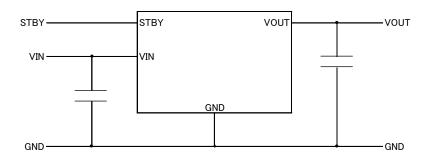
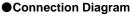
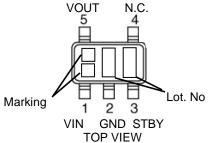


Fig.1 Application Circuit

OProduct structure: Silicon monolithic integrated circuit OThis product is not designed protection against radioactive rays.



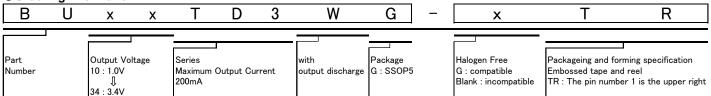




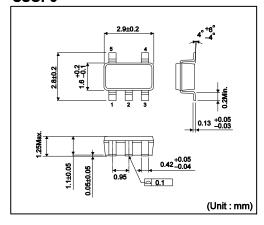
●Pin Descriptions

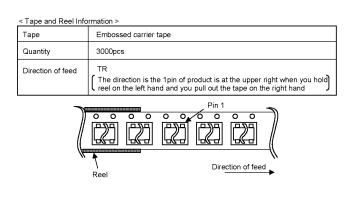
SSOP5						
PIN No.	Symbol	Function				
1	VIN	Power Supply Voltage				
2	GND	Grouding				
3	STBY	ON/OFF control of output voltage				
Ŭ		(High: ON, Low: OFF)				
4	N.C.	Unconnected Terminal				
5	VOUT	Output Voltage				

Ordering Information



SSOP5





Lineup

Marking	F0	L6	F1	M0	L5	F2	F3	F4	F5
Output Voltage	1.0V	1.1V	1.2V	1.25V	1.3V	1.5V	1.8V	1.85V	1.9V
Part Number	BU10	BU11	BU12	BU1C	BU13	BU15	BU18	BU1J	BU19
		,		,	,				_
	F6	F7	F8	F9	G0	G1	G2	G3	G4
	2.0V	2.1V	2.5V	2.6V	2.7V	2.8V	2.85V	2.9V	3.0V
	BU20	BU21	BU25	BU26	BU27	BU28	BU2J	BU29	BU30

G5	G6	G7	G8
3.1V	3.2V	3.3V	3.4V
BU31	BU32	BU33	BU34

● Absolute Maximum Ratings (Ta=25°C)

<u> </u>			
PARAMETER	Symbol	Limit	Unit
Power Supply Voltage	VMAX	-0.3 ~ +6.5	V
Power Dissipation	Pd	540(*1)	mW
Maximum junction temperature	TjMAX	+125	°C
Operating Temperature Range	Topr	-40 ~ +85	°C
Storage Temperature Range	Tstg	-55 ~ +125	°C

^(*1)Pd deleted at 5.4mW/°C at temperatures above Ta=25°C, mounted on 70x70x1.6 mm glass-epoxy PCB.

RECOMMENDED OPERATING RANGE (not to exceed Pd)

PARAMETER	Symbol	Limit	Unit
Power Supply Voltage	VIN	1.7~6.0	٧
Maximum Output Current	IMAX	200	mA

OPERATING CONDITIONS

PARAMETER	Symbol	MIN.	TYP.	MAX.	Unit	CONDITION	
Input Capacitor	Cin	0. 22 (*2)	0. 47	-	μF	- Ceramic capacitor recommended	
Output Capacitor	Co	0. 22 (*2)	0. 47	-	μF		

(*2) Make sure that the output capacitor value is not kept lower than this specified level across a variety of temperature, DC bias, changing as time progresses characteristic.

● Electrical Characteristics

(Ta=25°C, VIN=VOUT+1.0V (*3), STBY=VIN, Cin=0.47 μ F, Co=0.47 μ F, unless otherwise noted.)

PARAMETER		Symbol	Limit			Unit	Conditions	
		Symbol	MIN.	TYP. MAX.		Unit	Conditions	
Overall Device								
0		\	VOUT × 0.99		VOUT × 1.01	.,	IOUT=10 μ A, VOUT≧2.5V	
Output Voltage		VOUT	VOUT-25mV	VOUT	VOUT+25mV	V	IOUT=10 μ A, VOUT < 2.5V	
Operating Current		IIN	-	35	60	μΑ	IOUT=0mA	
Operating Current (STB)	()	ISTBY	-	-	1.0	μΑ	STBY=0V	
Ripple Rejection Ratio		RR	45	70	_	dB	VRR=-20dBv, fRR=1kHz, IOUT=10mA	
			-	800	1100	mV	1.0V≦VOUT < 1.2V(IOUT=200mA)	
			_	600	900	mV	1.2V \(\sqrt{VOUT} < 1.5V(IOUT=200mA)	
Dropout Voltage		VSAT	_	440	700	mV	1.5V≦VOUT<1.8V(IOUT=200mA)	
			_	380	600	mV	1.8V≦VOUT < 2.5V(IOUT=200mA)	
			_	280	540	mV	2.5V≦VOUT≦2.6V(IOUT=200mA)	
			-	260	500	mV	2.7V≦VOUT≦2.85V(IOUT=200mA)	
			_	240	460	mV	2.9V≦VOUT≦3.1V(IOUT=200mA)	
			-	220	420	mV	3.2V≦VOUT≦3.4V(IOUT=200mA)	
Line Regulation		VDL	-	2	20	mV	VIN=VOUT+1.0V to 5.5V (*4), IOUT=10 μ A	
Load Regulation		VDLO	-	10	80	mV	IOUT=0.01mA to 100mA	
Over Current Protect	ction (OCP)						
Limit Current		ILMAX	220	400	700	mA	Vo=VOUT*0.95	
Short Current		ISHORT	20	70	150	mA	Vo=0V	
Standby Block								
Discharge Resistor		RDSC	20	50	80	Ω	VIN=4.0V, STBY=0V, VOUT=4.0V	
STBY Pin Pull-down Cu	rrent	ISTB	0.1	0.6	2.0	μΑ	STBY=1.5V	
STRV Control Voltage	ON	VSTBH	1.2	-	6.0	٧		
STBY Control Voltage	OFF	VSTBL	-0.3	-	0.3	V		

This product is not designed for protection against radioactive rays.

- (*3) VIN=2.5V for VOUT \leq 1.5V
- (*4) VIN=2.5V to 3.6V for VOUT \leq 1.5V

Block Diagrams

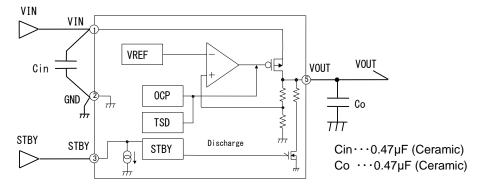
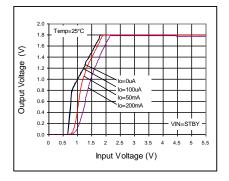
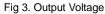


Fig. 2 Block Diagrams

● Reference data BU18TD3WG (Ta=25°C unless otherwise specified.)





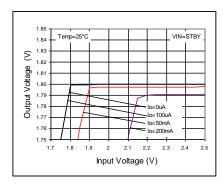


Fig 4. Line Regulation

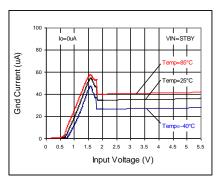


Fig 5. Circuit Current IGND

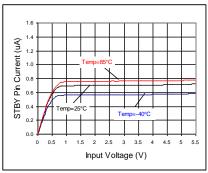


Fig 6. VSTBY - ISTBY

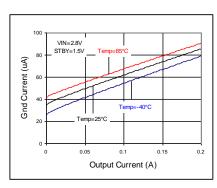


Fig 7. IOUT - IGND

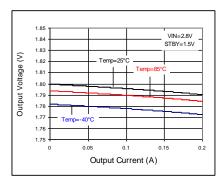


Fig 8. Load Regulation

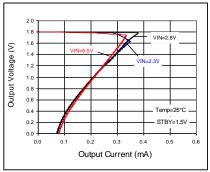


Fig 9. OCP Threshold

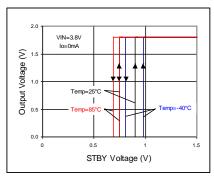


Fig 10. STBY Threshold

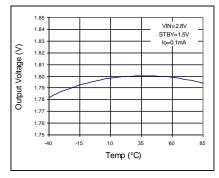


Fig 11. VOUT - Temp

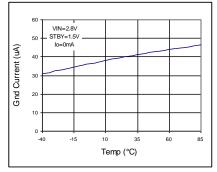


Fig 12. IGND - Temp

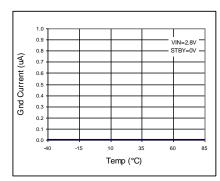


Fig 13. IGND - Temp (STBY)

BU18TD3WG (Ta=25°C unless otherwise specified.) ●Reference data

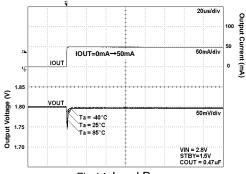


Fig 14. Load Response

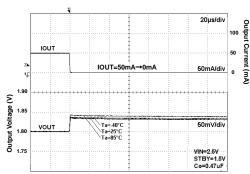


Fig 15. Load Response

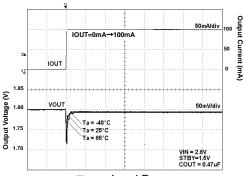


Fig 16. Load Response

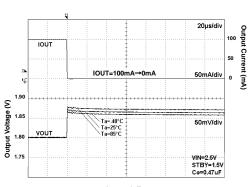


Fig 17. Load Response

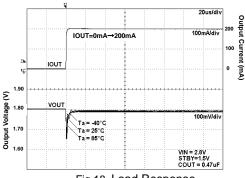


Fig 18. Load Response

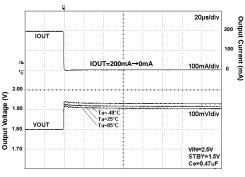


Fig 19. Load Response

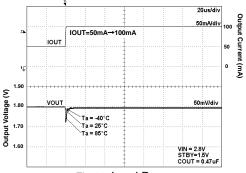


Fig 20. Load Response

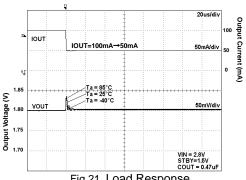
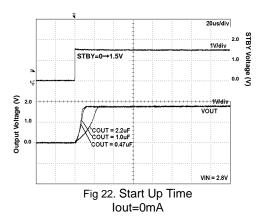
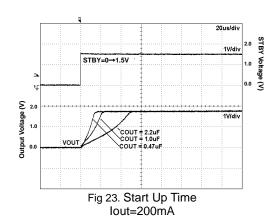
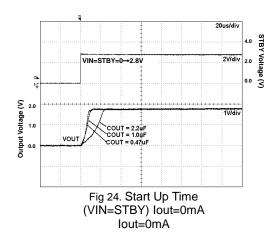


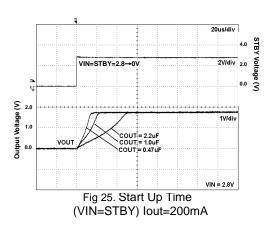
Fig 21. Load Response

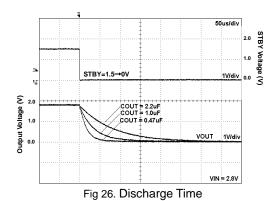
● Reference data BU18TD3WG (Ta=25°C unless otherwise specified.)











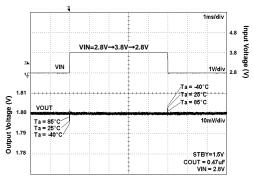


Fig 27. VIN Response

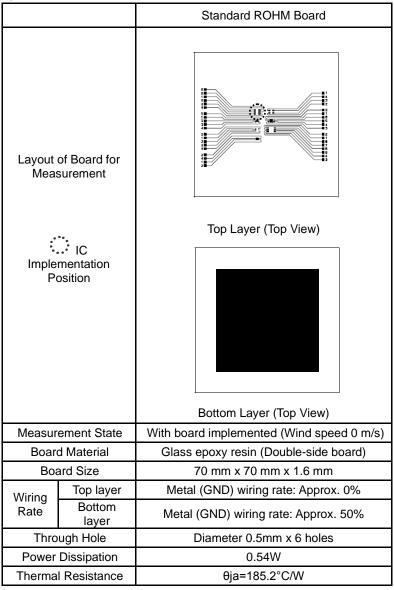
About power dissipation (Pd)

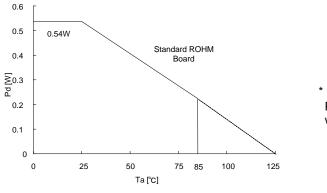
As for power dissipation, an approximate estimate of the heat reduction characteristics and internal power consumption of IC are shown, so please use these for reference. Since power dissipation changes substantially depending on the implementation conditions (board size, board thickness, metal wiring rate, number of layers and through holes, etc.), it is recommended to measure Pd on a set board. Exceeding the power dissipation of IC may lead to deterioration of the original IC performance, such as causing operation of the thermal shutdown circuit or reduction in current capability. Therefore, be sure to prepare sufficient margin within power dissipation for usage.

Calculation of the maximum internal power consumption of IC (PMAX)

PMAX=(VIN-VOUT)×IOUT(MAX.) (VIN: Input voltage VOUT: Output voltage IOUT(MAX): Maximum output current)

Measurement conditions





 Please design the margin so that PMAX becomes is than Pd (PMAX<Pd) within the usage temperature range

Fig. 28 SSOP5 Power dissipation heat reduction characteristics (Reference)

Operation Notes

1.) Absolute maximum ratings

Use of the IC in excess of absolute maximum ratings (such as the input voltage or operating temperature range) may result in damage to the IC. Assumptions should not be made regarding the state of the IC (e.g., short mode or open mode) when such damage is suffered. If operational values are expected to exceed the maximum ratings for the device, consider adding protective circuitry (such as fuses) to eliminate the risk of damaging the IC.

2) GND notential

The potential of the GND pin must be the minimum potential in the system in all operating conditions. Never connect a potential lower than GND to any pin, even if only transiently.

3.) Thermal design

Use a thermal design that allows for a sufficient margin for that package power dissipation rating (Pd) under actual operating conditions.

4.) Inter-pin shorts and mounting errors

Use caution when orienting and positioning the IC for mounting on printed circuit boards. Improper mounting or shorts between pins may result in damage to the IC.

5.) Operation in strong electromagnetic fields

Strong electromagnetic fields may cause the IC to malfunction. Caution should be exercised in applications where strong electromagnetic fields may be present.

6.) Common impedance

Wiring traces should be as short and wide as possible to minimize common impedance. Bypass capacitors should be use to keep ripple to a minimum.

7.) Voltage of STBY pin

To enable standby mode for all channels, set the STBY pin to 0.3 V or less, and for normal operation, to 1.2 V or more. Setting STBY to a voltage between 0.3 and 1.2 V may cause malfunction and should be avoided. Keep transition time between high and low (or vice versa) to a minimum.

Additionally, if STBY is shorted to VIN, the IC will switch to standby mode and disable the output discharge circuit, causing a temporary voltage to remain on the output pin. If the IC is switched on again while this voltage is present, overshoot may occur on the output. Therefore, in applications where these pins are shorted, the output should always be completely discharged before turning the IC on.

8.) Over-current protection circuit (OCP)

This IC features an integrated over-current and short-protection circuitry on the output to prevent destruction of the IC when the output is shorted. The OCP circuitry is designed only to protect the IC from irregular conditions (such as motor output shorts) and is not designed to be used as an active security device for the application. Therefore, applications should not be designed under the assumption that this circuitry will engage.

9.) Thermal shutdown circuit (TSD)

This IC also features a thermal shutdown circuit that is designed to turn the output off when the junction temperature of the IC exceeds about 150°C. This feature is intended to protect the IC only in the event of thermal overload and is not designed to guarantee operation or act as an active security device for the application. Therefore, applications should not be designed under the assumption that this circuitry will engage.

10.) Input/output capacitor

Capacitors must be connected between the input/output pins and GND for stable operation, and should be physically mounted as close to the IC pins as possible. The input capacitor helps to counteract increases in power supply impedance, and increases stability in applications with long or winding power supply traces. The output capacitance value is directly related to the overall stability and transient response of the regulator, and should be set to the largest runstable region the application to increase these characteristics. During design, keep in mind that in general, ceramic capacitors have a wide range of tolerances, temperature coefficients and DC bias characteristics, and that their capacitance values tend to decrease over time. Confirm these details before choosing appropriate capacitors for your application. (Please refer the technical note, regarding ceramic capacitor of recommendation)

Cout=0.47 μ F, Cin=0.47 μ F, Temp=+25°C

11.) About the equivalent series resistance (ESR) of a ceramic capacitor

Capacitors generally have ESR (equivalent series resistance) and it operates stably in the ESR-IOUT area shown on the right. Since ceramic capacitors, tantalum capacitors, electrolytic capacitors, etc. generally have different ESR, please check the ESR of the capacitor to be used and use it within the stability area range shown in the right graph for evaluation of the actual application.

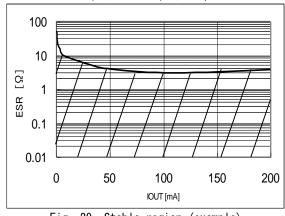
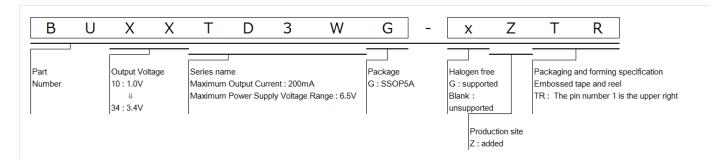


Fig. 29 Stable region (example)

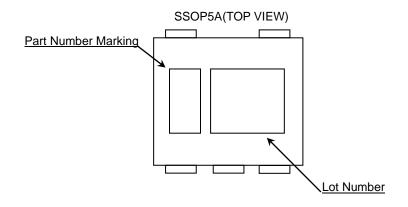
●Revision History

Date	Revision	Changes			
7.Feb.2013	001	New Release			
30.Jul.2013	002	Adding a Revision History. VSBYH is changed.			
21.Aug.2013	003	ELECTRICAL CHARACTERISTICS of each Output Voltage is removed. Adding dropout voltage.			
04.Dec.2020	004	p.10-2,p.10-3,Updated Packages and Part Numbers			

Ordering Information

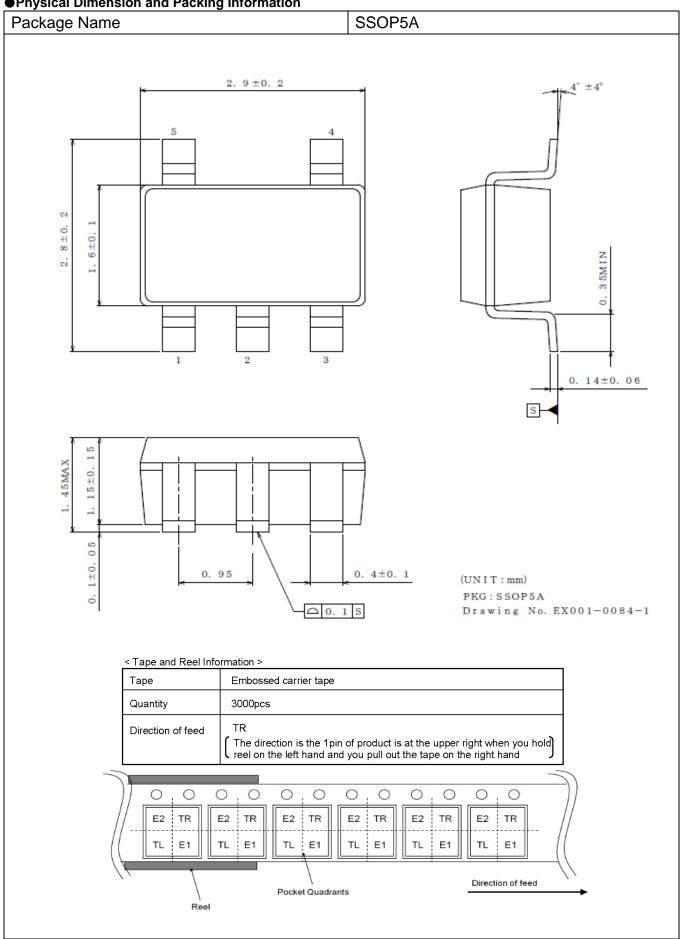


Marking Diagram



Part Number	Output Voltage [V]	Part Number Marking
BU10TD3WG	1.0	F0
BU11TD3WG	1.1	L6
BU12TD3WG	1.2	F1
BU1CTD3WG	1.25	M0
BU13TD3WG	1.3	L5
BU15TD3WG	1.5	F2
BU18TD3WG	1.8	F3
BU1JTD3WG	1.85	F4
BU19TD3WG	1.9	F5
BU20TD3WG	2.0	F6
BU21TD3WG	2.1	F7
BU25TD3WG	2.5	F8
BU26TD3WG	2.6	F9
BU27TD3WG	2.7	G0
BU28TD3WG	2.8	G1
BU2JTD3WG	2.85	G2
BU29TD3WG	2.9	G3
BU30TD3WG	3.0	G4
BU31TD3WG	3.1	G5
BU32TD3WG	3.2	G6
BU33TD3WG	3.3	G7
BU34TD3WG	3.4	G8

●Physical Dimension and Packing Information



Notice

Precaution on using ROHM Products

1. Our Products are designed and manufactured for application in ordinary electronic equipment (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JÁPAN	USA	EU	CHINA
CLASSⅢ	CL ACCIII	CLASS II b	CL ACCIII
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
 - [a] Installation of protection circuits or other protective devices to improve system safety
 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
- 3. Our Products are designed and manufactured for use under standard conditions and not under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

Precaution for Foreign Exchange and Foreign Trade act

Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

Precaution Regarding Intellectual Property Rights

- 1. All information and data including but not limited to application example contained in this document is for reference only. ROHM does not warrant that foregoing information or data will not infringe any intellectual property rights or any other rights of any third party regarding such information or data.
- 2. ROHM shall not have any obligations where the claims, actions or demands arising from the combination of the Products with other articles such as components, circuits, systems or external equipment (including software).
- 3. No license, expressly or implied, is granted hereby under any intellectual property rights or other rights of ROHM or any third parties with respect to the Products or the information contained in this document. Provided, however, that ROHM will not assert its intellectual property rights or other rights against you or your customers to the extent necessary to manufacture or sell products containing the Products, subject to the terms and conditions herein.

Other Precaution

- 1. This document may not be reprinted or reproduced, in whole or in part, without prior written consent of ROHM.
- 2. The Products may not be disassembled, converted, modified, reproduced or otherwise changed without prior written consent of ROHM.
- In no event shall you use in any way whatsoever the Products and the related technical information contained in the Products or this document for any military purposes, including but not limited to, the development of mass-destruction weapons.
- 4. The proper names of companies or products described in this document are trademarks or registered trademarks of ROHM, its affiliated companies or third parties.

Notice-PGA-E Rev.004

General Precaution

- 1. Before you use our Products, you are requested to carefully read this document and fully understand its contents. ROHM shall not be in any way responsible or liable for failure, malfunction or accident arising from the use of any ROHM's Products against warning, caution or note contained in this document.
- 2. All information contained in this document is current as of the issuing date and subject to change without any prior notice. Before purchasing or using ROHM's Products, please confirm the latest information with a ROHM sales representative.
- 3. The information contained in this document is provided on an "as is" basis and ROHM does not warrant that all information contained in this document is accurate and/or error-free. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties resulting from inaccuracy or errors of or concerning such information.

Notice – WE Rev.001